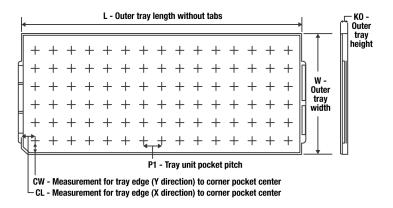


Carrier Material Report for MSP430F5529IPN

Tray Information:



Device	Package	Package	Pins	SPQ	Unit	Max	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW
	Drawing	Type			Array	Temp						(mm)
					Matrix	(°C)						
MSP4	PN	LQFP	80	119	7 x 17	150	315	135.9	7620	17.9	14.3	13.95
30F55												
29IPN												

Images above are just a representation of the carrier. Actual carrier may vary. Please reference the dimensions provided in the table.

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